

ZZ101277  
(ON 01M1V1R)台票圖

版数 REV.	年月日 DATE	DCN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.
2	10.Feb.2006	059307	CORRECTION OF ERROR IN WRITING	E.MURANO	Y.YAHIRO		K.Hisabumi

DESIGNATION

MM50-200B\*-E1E

SERIES PREFIX  
シリーズ名

NO. OF CONTACTS  
芯数

SOCKET TYPE  
ソケットタイプ  
B:LATCH TYPE SMT

錫または錫合金(無鉛)  
(LEAD FREE/TIN/TIN ALLOY)

CONTACT FINISH  
接点仕上げ  
1:Au(0.1μm MIN) OVER NI

MODIFY CODE  
モディファイコード  
E:6.5mm HIGH

KEYING TYPE(Detail A) 2:TYPE B(1.8V)  
キタイプ キタイプ

DETAIL A  
(SCALE 5:1)  
(REF.TABLE 1)

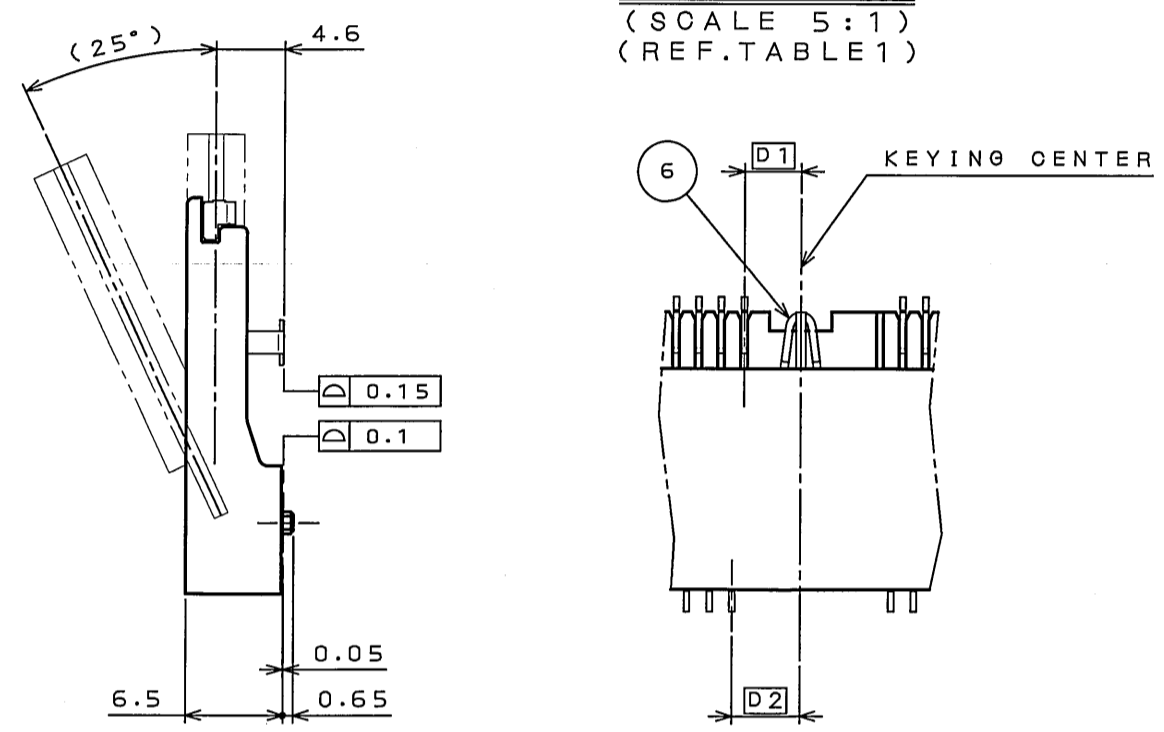
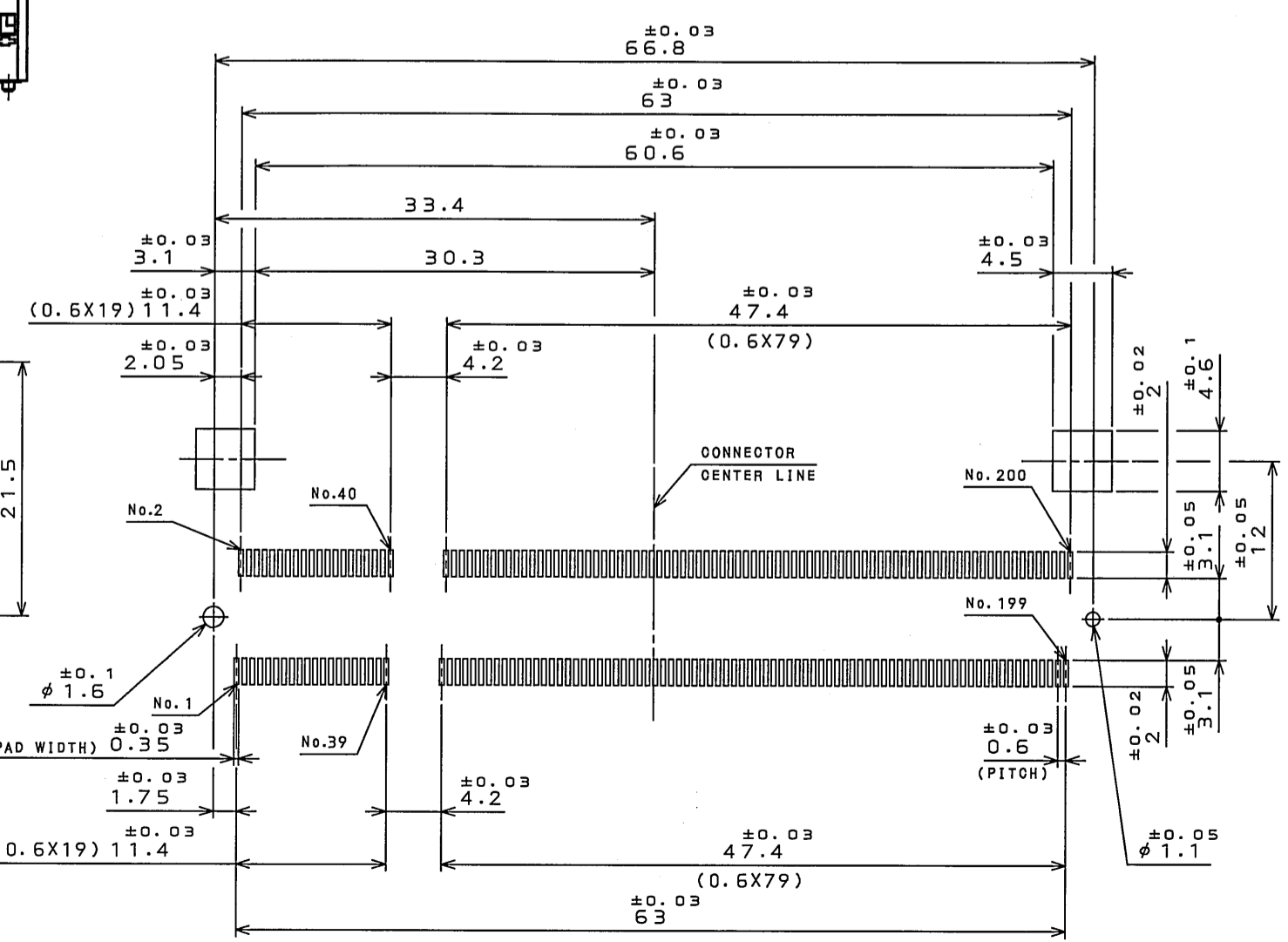


TABLE 2  
DISCRIMINATION MARK

PARTS NAME	VOLTAGE MARK	ABRIDGED PART NUMBER
MM50-200B1-E1E	2.5V	E1E
MM50-200B2-E1E	1.8V	2-E1E

APPLICABLE P.C.B. DIMENSION(REF.)  
適合基板寸法(参考)



APPLICABLE DIMM(REF.)

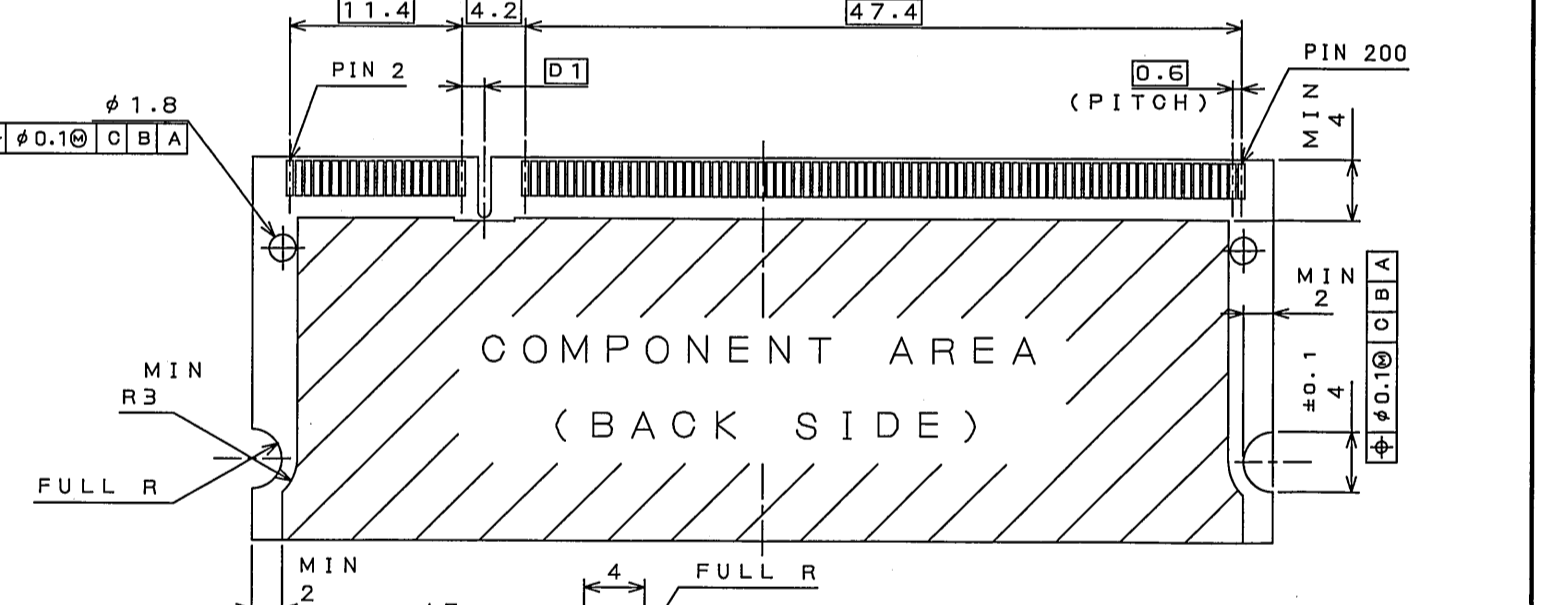
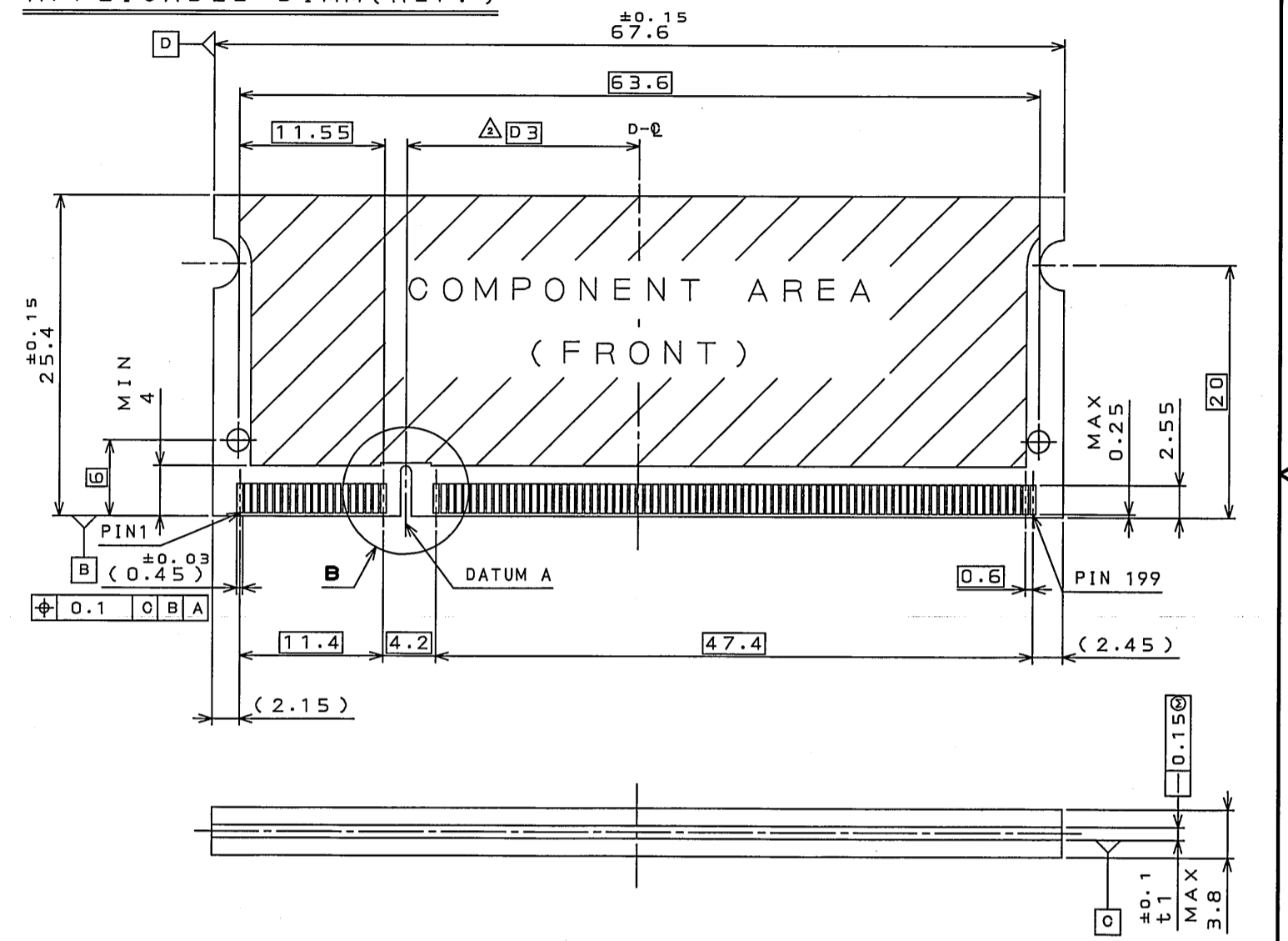
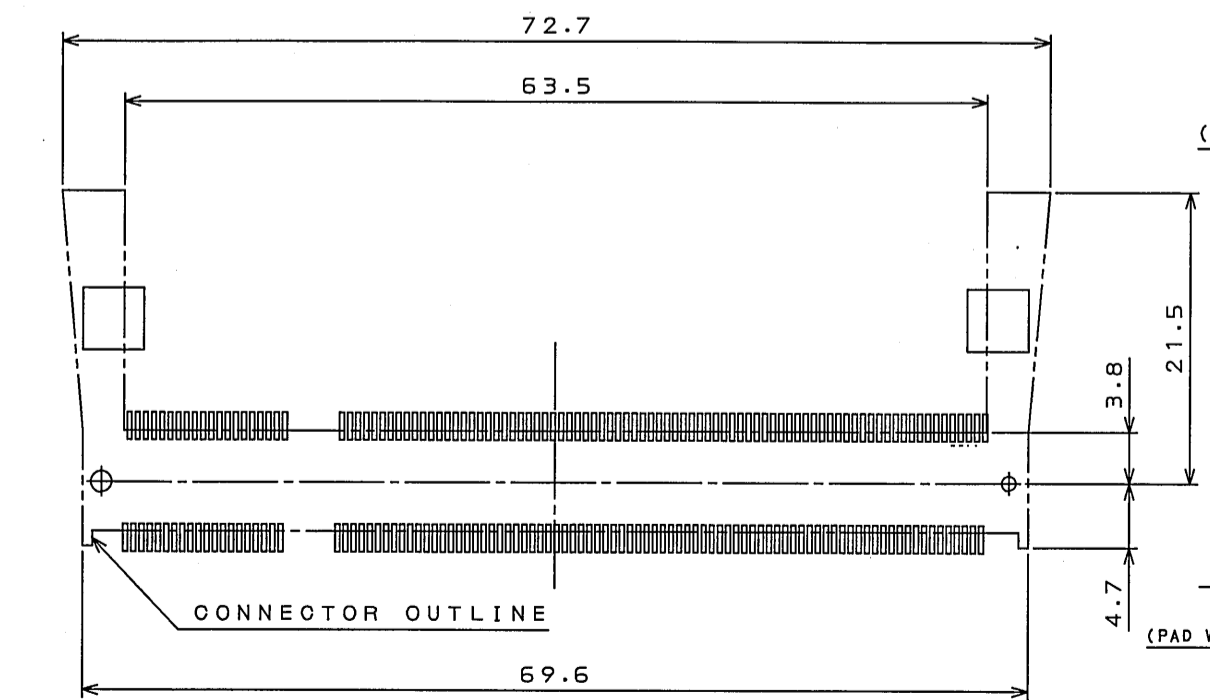
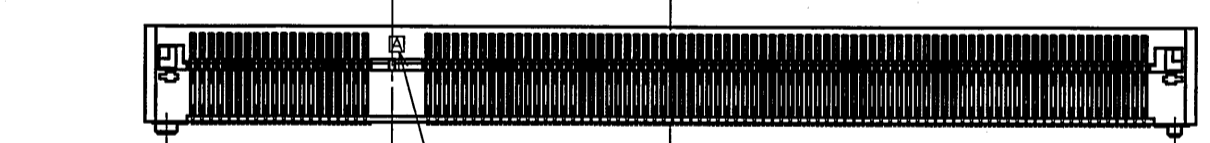
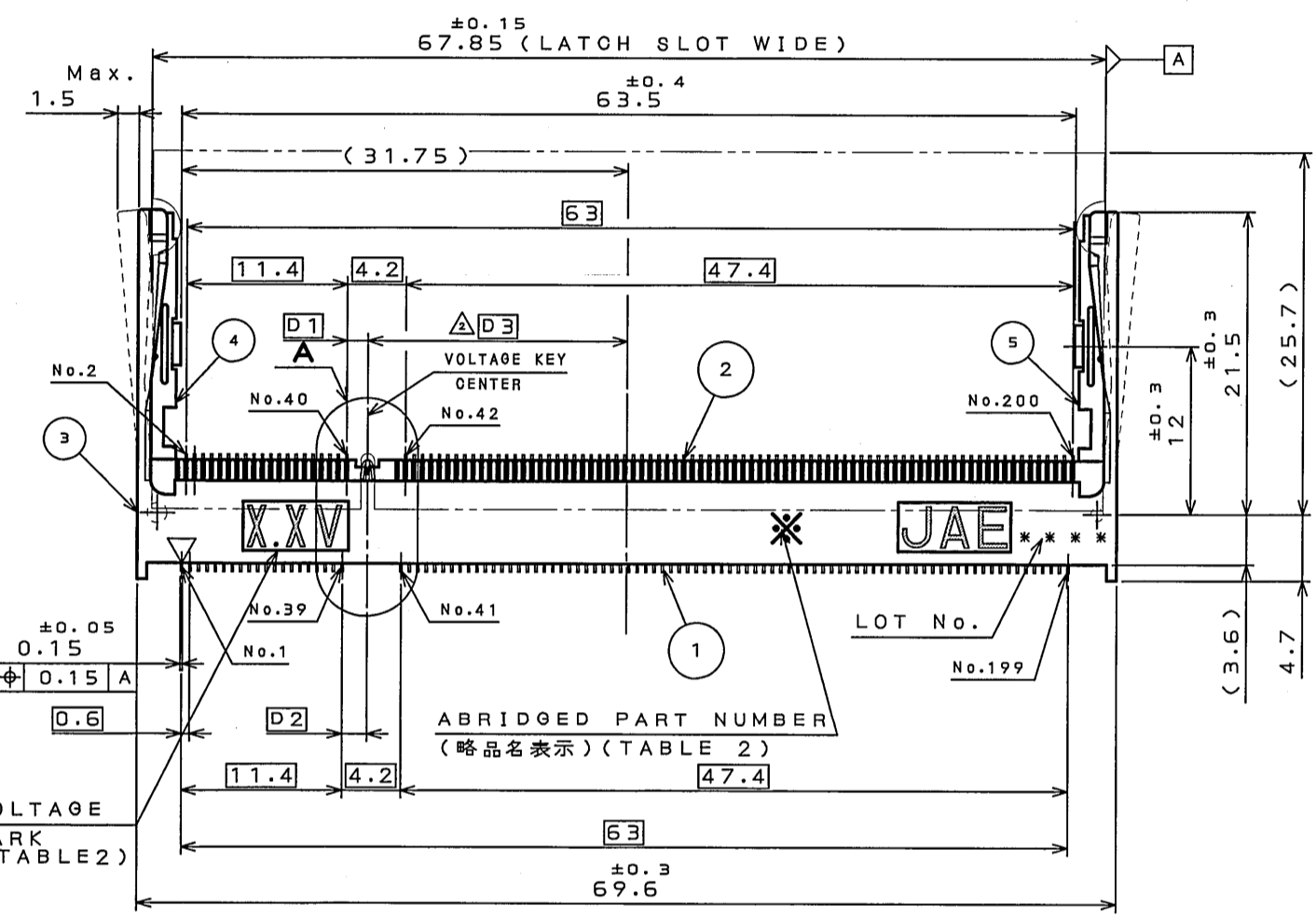
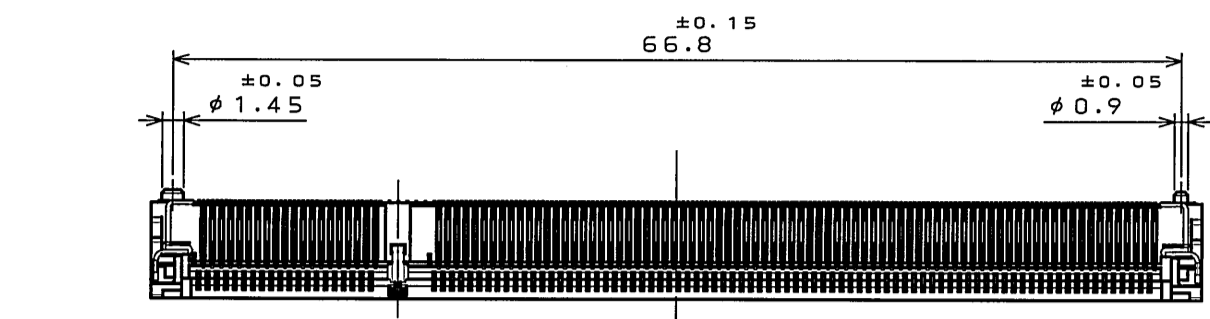
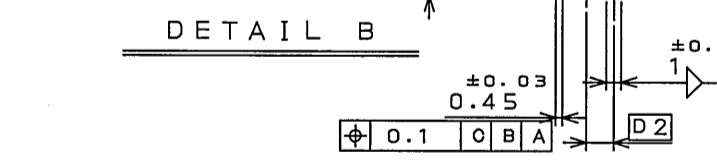


TABLE 1  
MECHANICAL KEYING

POWER SPPLY	D1	D2	D3
2.5V(TYPE A)	1.5	1.8	18.45
1.8V(TYPE B)	2.4	2.7	17.55



KEY	1	STAINLESS		
5	HOLD DOWN 2	1	PHOSPHOR BRONZE	TIN PLATING
4	HOLD DOWN 1	1	PHOSPHOR BRONZE	TIN PLATING
3	INSULATOR	1	GLASS FILLED LOP	UL94 V-0 COLOR WHITE
2	BOTTOM SIDE CONTACT	100	PHOSPHOR BRONZE	CONTACT AREA:Au(0.1μm MIN) OVER NI SOLDERING AREA:GOLD FLASH OVER NI
1	TOP SIDE CONTACT	100	PHOSPHOR BRONZE	CONTACT AREA:Au(0.1μm MIN) OVER NI SOLDERING AREA:GOLD FLASH OVER NI

符号 NO.	名 DESCRIPTION	個数 QTY.	材 MATERIAL	料 料	仕 FINISH	備 考 REMARKS		
仕様書(SPECIFICATION)	JACS-1655-01	第1版(ORIGINAL DATE)	20.May.2004	尺度(SCALE)	2:1	シリーズ(SERIES)	MM50	日本航空電子工業株式会社
公差(GENERAL TOLERANCE)		製図 DR.		名 称(TITLE)				JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.
寸法(DIMENSION)	角度(ANGLES)	担当 CHK.	R.KATOU	MM50				
. ±0.8	° ±	査閲 APPD.	Y.YAHIRO	-200B*-E1E				
.X ±0.4	°X' ±	承認 APPD.	S.KASHIWAQI					
.XX ±0.1								
.XXX ±								

DOF-0-213F(05.08)

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SIZE A2  
版数 (REV.) 2